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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/854,403	05/11/2001	Godefridus A.M. Hurkx	PHN 16,741A	8359
24738 7	7590 06/24/2004		EXAMINER	
PHILIPS ELECTRONICS NORTH AMERICA CORPORATION INTELLECTUAL PROPERTY & STANDARDS			MALDONADO, JULIO J	
1109 MCKAY	09 MCKAY DRIVE, M/S-41SJ		ART UNIT	PAPER NUMBER
	SAN JOSE, CA 95131			

DATE MAILED: 06/24/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
	09/854,403	HURKX ET AL.				
Office Action Summary	Examin r	Art Unit				
	Julio J. Maldonado	2823				
The MAILING DATE of this communication app Period for Reply	ars on the cov r sh et with the c	orrespondence address				
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply If NO period for reply is specified above, the maximum statutory period working the provided property of the period for reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	6(a). In no event, however, may a reply be tim within the statutory minimum of thirty (30) days ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONEI	ely filed s will be considered timely. the mailing date of this communication. O (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on 07 Ma	a <u>y 2004</u> .					
2a)⊠ This action is FINAL . 2b)□ This	action is non-final.					
	Since this application is in condition for allowance except for formal matters, prosecution as to the ments is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims	•					
4) ☐ Claim(s) 6-9 is/are pending in the application. 4a) Of the above claim(s) is/are withdraw 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 6-9 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or		·				
Application Papers						
9) The specification is objected to by the Examiner 10) The drawing(s) filed on is/are: a) access Applicant may not request that any objection to the of Replacement drawing sheet(s) including the correction 11) The oath or declaration is objected to by the Examiner	pted or b) objected to by the E lrawing(s) be held in abeyance. See on is required if the drawing(s) is obj	37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priority application from the International Bureau * See the attached detailed Office action for a list of the certified copies.	have been received. have been received in Application ty documents have been receive (PCT Rule 17.2(a)).	on No d in this National Stage				
Attachment(s)	Λ [] 1.4	(DTO 442)				
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary of Paper No(s)/Mail Da 5) Notice of Informal Pa 6) Other:					

DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United
- 2. Claims 6-8 are rejected under 35 U.S.C. 102(b) as being anticipated by Williams (U.S. 5,218,228).

In reference to claim 6, Williams et al. (Fig.6) in a related method to form a bipolar transistor including a first semiconductor region (124, 126) of a first conductivity type with a first connection conductor (144) forming a collector region of the bipolar transistor, a second semiconductor region (134, 136, 138) of a second conductivity type opposed to the first conductivity type with a second connection conductor (105, 145) forming a base region of the transistor, and a third semiconductor region (139) of the first conductivity type with a third connection conductor (146) forming an emitter region of the transistor; said method comprising forming the first semiconductor region (124. 126) of the first conductivity type; forming the second semiconductor region (134, 136, 138) on the first semiconductor region, the second semiconductor region having a partial region (136) with a smaller flux of dopant atoms than another part of the second semiconductor region (134, 136, 138); forming the third semiconductor region (139) which lies recessed in the other part, and outside the partial region (136), of the second semiconductor region; and providing first (144), second (105, 145) and third (146)

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connection conductors to the first (124, 126), second (134, 136, 138) and third (139) regions with a connection conductor respectively, wherein the second conductor (105, 145) is exclusively connected to the second semiconductor region (134, 136, 138) and is adjacent to the partial region of the second semiconductor region (134, 136, 138) (column 4, line 58 – column 5, line 41).

In reference to claim 7, Williams et al. teach wherein the partial region of the second semiconductor region is formed below the second connection conductor and is given a smaller thickness and a lower doping concentration than those in the other region (Fig.6).

In reference to claim 8, Williams et al. teach wherein the partial region of the second semiconductor region is given a smaller thickness than that in the other region (Fig.6).

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claim 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over Williams et al. ('228) in view of Blanchard (U.S. 4,345,265).

Williams et al. (Fig.6) in a related method to form a bipolar transistor including a first semiconductor region (124, 126) of a first conductivity type with a first connection conductor (144) forming a collector region of the bipolar transistor, a second

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semiconductor region (134, 136, 138) of a second conductivity type opposed to the first conductivity type with a second connection conductor (105, 145) forming a base region of the transistor, and a third semiconductor region (139) of the first conductivity type with a third connection conductor (146) forming an emitter region of the transistor; said method comprising forming the first semiconductor region (124, 126) of the first conductivity type; forming the second semiconductor region (134, 136, 138) on the first semiconductor region, the second semiconductor region having a partial region with a smaller flux of dopant atoms than other part of the second semiconductor region (134, 136, 138); forming the third semiconductor region (139) which lies recessed in the other part, and outside the partial region, of the second semiconductor region; and providing first (144), second (105, 145) and third (146) connection conductors to the first (124, 126), second (134, 136, 138) and third (139) regions with a connection conductor respectively, wherein the second conductor (105, 145) is exclusively connected to the second semiconductor region (134, 136, 138) and is adjacent to the partial region of the second semiconductor region (134, 136, 138) (column 4, line 58 – column 5, line 41). Williams et al. also teach forming semiconductive regions by implanting impurities (column 2, liens 15 – 26) but fail to teach wherein said implanting is ion implantation. However, Blanchard (Fig.5) in a related method to form a MOS device teaches forming semiconductive regions of a conductivity type by means of ion implantation (column 6, lines 33 – 44). It would have been within the scope of one of ordinary skill in the art to combine the teachings of Williams et al. and Blanchard to enable the implantation step of Williams et al. to be performed according to the teachings of Blanchard because one

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of ordinary skill in the art at the time the invention was made would have been motivated to look to alternative suitable methods of performing the disclosed implantation step of Williams et al. and art recognized suitability for an intended purpose has been recognized to be motivation to combine. MPEP 2144.07.

Response to Arguments

5. Applicant's arguments filed 05/03/2004 have been fully considered but they are not persuasive.

Applicants argue, "... the Office Action fails to show correspondence between each of the claimed limitations and the cited '228 reference. More specifically, the '228 reference appears to be unrelated to the instant invention as the Office Action fails to identify where and how various aspects of the claimed first, second, and third semiconductor regions correspond to the '228 reference, and where these limitations are taught in the '228 reference, e.g., relative to the claimed "partial region with a smaller flux of dopant atoms" in the second semiconductor region...the '228 discussion of figure 6 does not appear to include any teachings that would correspond to the claimed invention...with particular respect to claims 7 and 8, the Office Action fails to identify correspondence to the claim limitations involving a partial region that has a smaller thickness than the remainder of the region as claimed...". In response to applicant's argument that Williams et al. ('228) is nonanalogous art, it has been held that a prior art reference must either be in the field of applicant's endeavor or, if not, then be reasonably pertinent to the particular problem with which the applicant was concerned. in order to be relied upon as a basis for rejection of the claimed invention. See In re

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Oetiker, 977 F.2d 1443, 24 USPQ2d 1443 (Fed. Cir. 1992). In this case, the claimed invention teaches a method to form a bipolar transistor. As explained above in this Office Action, Williams et al. fairly teach the claimed invention.

Conclusion

6. THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to examiner Julio J. Maldonado whose telephone number is (571) 272-1864. The examiner can normally be reached on Monday through Friday. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Olik Chaudhuri, can be reached on (571) 272-1855. The fax number for this group is 703-872-9306 for before final submissions, 703-872-9306 for after final submissions and the customer service number for group 2800 is (703) 306-3329. Updates can be found at http://www.uspto.gov/web/info/2800.htm.

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Julio J. Maldonado Patent Examiner Art Unit 2823

Julio J. Maldonado June 18, 2004

> George Fourson Primary Examiner